

**COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION**

As a below named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole Inventor (If only one name is listed below) or an original, first and joint Inventor (If plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the Inventor entitled:

**DSP (DIGITAL SIGNAL PROCESSING) ARCHITECTURE WITH A WIDE MEMORY BANDWIDTH AND A MEMORY MAPPING METHOD THEREOF**

The specification of which is attached hereto, unless the following box is checked:

☐ was filed on \_\_\_\_\_ as United States Application Number or PCT Application Number \_\_\_\_\_ and was amended on (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefit(s) under 35 U.S.C. § 119(a)-(c) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filing date before that at the application on which priority is claimed.

**Prior Foreign Application(s)**

**Priority NOT  
Claimed**

2003-58781  
(Number)

Republic of Korea  
(Country)

25/ August/2003  
Day/Month/Year Filed

☐

I hereby claim the benefit under 35 U.S.C. § 120 or § 110(c) of any United States application(s), or § 365(c) of any PCT International application designating the United States listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application(s) in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

(Application Serial No.)

(Filing Date)

(Status-patented, pending, abandoned)

I hereby appoint the attorneys and agents of Stanzone & Kim, LLP under USPTO Customer No. 38,209 to prosecute the application and to transact all business in the Patent and Trademark Office connected therewith.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issues thereon.

Full name of sole or first inventor: Hyun-kyu YUN

Inventor's Signature [Signature]

Date: 03/13/04

Residence: Seongnam-si, Korea

Citizenship: Republic of Korea

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X - Additional Inventors are being named on separately numbered sheets attached hereto.

## COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

Full name of second inventor: Han-tak KWAK

Inventor's Signature: *Han-tak Kwak* Date: 03/13/04  
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Full name of third inventor: \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Residence: \_\_\_\_\_ Citizenship: \_\_\_\_\_  
Mailing address: \_\_\_\_\_

Full name of fourth inventor: \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Residence: \_\_\_\_\_ Citizenship: \_\_\_\_\_  
Mailing address: \_\_\_\_\_

Full name of fifth inventor: \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Residence: \_\_\_\_\_ Citizenship: \_\_\_\_\_  
Mailing address: \_\_\_\_\_

Full name of sixth inventor: \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Residence: \_\_\_\_\_ Citizenship: \_\_\_\_\_  
Mailing address: \_\_\_\_\_

Full name of seventh inventor: \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Residence: \_\_\_\_\_ Citizenship: \_\_\_\_\_  
Mailing address: \_\_\_\_\_

Full name of eighth inventor: \_\_\_\_\_

Inventor's Signature: \_\_\_\_\_ Date: \_\_\_\_\_  
Residence: \_\_\_\_\_ Citizenship: \_\_\_\_\_  
Mailing address: \_\_\_\_\_